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### **Understanding Embedded - Microprocessors**

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

## **Applications of Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Product Status Obsolete  Core Processor ARM7TDMI  Number of Cores/Bus Width 1 Core, 32-Bit  Speed 74MHz  Co-Processors/DSP -  RAM Controllers SDRAM  Graphics Acceleration No  Display & Interface Controllers Keypad, LCD, Touchscreen  Ethernet -  SATA -  USB -  Voltage - I/O 2.5V, 2.7V, 3.0V, 3.3V  Operating Temperature -40°C ~ 85°C (TA)  Security Features Hardware ID  Package / Case 256-LFBGA		
Core Processor  ARM7TDMI  Number of Cores/Bus Width  1 Core, 32-Bit  Speed  74MHz  Co-Processors/DSP  - RAM Controllers  SDRAM  Graphics Acceleration  No  Display & Interface Controllers  Ethernet  - SATA  - USB  Voltage - I/O  2.5V, 2.7V, 3.0V, 3.3V  Operating Temperature  Package / Case  ARM7TDMI  ARM7TDMI  1 Core, 32-Bit  SDRAM  -  What  Expect of the processors/DSP  -  ARM Controllers  SDRAM  No  No  No  Coprating Temperature  -40°C ~ 85°C (TA)  Security Features  Hardware ID  Package / Case	s	
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Graphics Acceleration  Display & Interface Controllers  Keypad, LCD, Touchscreen  Ethernet  -  SATA  -  USB  -  Voltage - I/O  2.5V, 2.7V, 3.0V, 3.3V  Operating Temperature  -40°C ~ 85°C (TA)  Security Features  Hardware ID  Package / Case	cessors/DSP	-
Display & Interface Controllers  Ethernet  - SATA  - USB  - Voltage - I/O  Operating Temperature  -40°C ~ 85°C (TA)  Package / Case  Ethernet  - Keypad, LCD, Touchscreen  Ethernet  - Keypad, LCD, Touchscreen  Expendit Seypad, LCD, Touchscreen  - Keypad, LCD, Touchscreen  -  SATA  - USB  - Voltage - I/O  2.5V, 2.7V, 3.0V, 3.3V  Operating Temperature  -40°C ~ 85°C (TA)  Security Features  Hardware ID  Package / Case	ontrollers	SDRAM
Ethernet       -         SATA       -         USB       -         Voltage - I/O       2.5V, 2.7V, 3.0V, 3.3V         Operating Temperature       -40°C ~ 85°C (TA)         Security Features       Hardware ID         Package / Case       256-LFBGA	cs Acceleration	No
SATA       -         USB       -         Voltage - I/O       2.5V, 2.7V, 3.0V, 3.3V         Operating Temperature       -40°C ~ 85°C (TA)         Security Features       Hardware ID         Package / Case       256-LFBGA	y & Interface Controllers	Keypad, LCD, Touchscreen
USB  Voltage - I/O  2.5V, 2.7V, 3.0V, 3.3V  Operating Temperature  -40°C ~ 85°C (TA)  Security Features  Hardware ID  Package / Case  256-LFBGA	et .	-
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Package / Case 256-LFBGA	ting Temperature	-40°C ~ 85°C (TA)
	ty Features	Hardware ID
Supplier Dayles Package 256 DRGA (17v17)	ge / Case	256-LFBGA
Supplier Device rackage 250-FBOA (17X17)	er Device Package	256-PBGA (17x17)
Purchase URL https://www.e-xfl.com/product-detail/cirrus-logic/ep7312-ib	ise URL	https://www.e-xfl.com/product-detail/cirrus-logic/ep7312-ib

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



# **System Design**

As shown in system block diagram, simply adding desired memory and peripherals to the highly integrated

EP7312 completes a low-power system solution. All necessary interface logic is integrated on-chip.

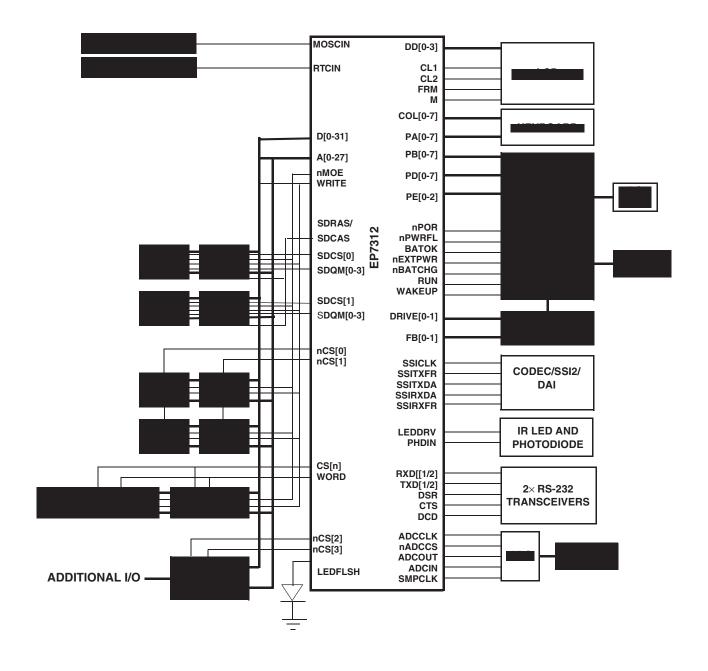


Figure 1. A Fully-Configured EP7312-Based System

Note: A system can only use one of the following peripheral interfaces at any given time: SSI2,CODEC or DAI.



# **Pin Multiplexing**

Table 18 shows the pin multiplexing of the DAI, SSI2 and the CODEC. The selection between SSI2 and the CODEC is controlled by the state of the SERSEL bit in SYSCON2. The choice between the SSI2, CODEC, and the DAI is controlled by the DAISEL bit in SYSCON3 (see the EP7312 User's Manualor more information).

Table 18. DAI/SSI2/CODEC Pin Multiplexing

Pin Mnemonic	I/O	DAI	SSI2	CODEC
SSICLK	I/O	SCLK	SSICLK	PCMCLK
SSITXDA	0	SDOUT	SSITXDA	PCMOUT
SSIRXDA	I	SDIN	SSIRXDA	PCMIN
SSITXFR	I/O	LRCK	SSITXFR	PCMSYNC
SSIRXFR	I	MCLKIN	SSIRXFR	p/u
BUZ	0	MCLKOUT		

Table 19 shows the pins that have been multiplexed in the EP7312.

Table 19. Pin Multiplexing

Signal	Block	Signal	Block
nMOE	Static Memory	nSDCAS	SDRAM
nMWE	Static Memory	nSDWE	SDRAM
WRITE	Static Memory	nSDRAS	SDRAM
A[27:15]	Static Memory	DRA[0:12]	SDRAM
A[14:13]	Static Memory	DRA[13:14]	SDRAM
PD[7:6]	GPIO	SDQM[1:0]	SDRAM
RUN	System Configuration	CLKEN	System Configuration
nMEDCHG	Interrupt Controller	nBROM	Boot ROM select
PD[0]	GPIO	LEDFLSH	LED Flasher
PE[1:0]	GPIO	BOOTSEL[1:0]	System Configuration
PE[2]	GPIO	CLKSEL	System Configuration



## **DC-to-DC Converter Interface (PWM)**

 Provides two 96 kHz clock outputs with programmable duty ratio (from 1-in-16 to 15-in-16) that can be used to drive a positive or negative DC to DC converter

Table 14 shows the DC-to-DC Converter Interface pin assignments.

Table 14. DC-to-DC Converter Interface Pin Assignments

Pin Mnemonic	I/O	Pin Description
DRIVE[1:0]	I/O	PWM drive output
FB[1:0]	I	PWM feedback input

### **Timers**

- Internal (RTC) timer
- Two internal 16-bit programmable hardware countdown timers

## General Purpose Input/Output (GPIO)

- Three 8-bit and one 3-bit GPIO ports
- Supports scanning keyboard matrix

Table 15 shows the GPIO pin assignments.

Table 15. General Purpose Input/Output Pin Assignments

Pin Mnemonic	I/O	Pin Description
PA[7:0]	I	GPIO port A
PB[7:0]	I	GPIO port B
PD[0]/LEDFLSH (Note)	I/O	GPIO port D
PD[5:1]	I/O	GPIO port D
PD[7:6]/SDQM[1:0] (Note)	I/O	GPIO port D
PE[1:0]/BOOTSEL[1:0] (Note)	1	GPIO port E
PE[2]/CLKSEL (Note)	I	GPIO port E

Note: Pins are multiplexed. See Table 19 on page 11 for more information.

# **Hardware Debug Interface**

Full JTAG boundary scan and Embedded ICE<sup>®</sup> support

Table 16 shows the Hardware Debug Interface pin assignments.

Table 16. Hardware Debug Interface Pin Assignments

Pin Mnemonic	I/O	Pin Description
TCLK	I	JTAG clock
TDI	I	JTAG data input
TDO	0	JTAG data output
nTRST	I	JTAG async reset input
TMS	I	JTAG mode select

#### **LED Flasher**

A dedicated LED flasher module can be used to generate a low frequency signal on Port D pin 0 for the purpose of blinking an LED without CPU intervention. The LED flasher feature is ideal as a visual annunciator in battery powered applications, such as a voice mail indicator on a portable phone or an appointment reminder on a PDA. Table 17 shows the LED Flasher pin assignments.

- Software adjustable flash period and duty cycle
- Operates from 32 kHz RTC clock
- Will continue to flash in IDLE and STANDBY states
- 4 mA drive current

**Table 17. LED Flasher Pin Assignments** 

Pin Mnemonic		I/O	Pin Description
PD[0]/LEDFLSH	(Note)	0	LED flasher driver

Note: Pins are multiplexed. See Table 19 on page 11 for more information.

#### Internal Boot ROM

The internal 128-byte Boot ROM facilitates download of saved code to the on-board SRAM/FLASH.

## **Packaging**

The EP7312 is available in a 208-pin LQFP package, 256-ball PBGA package, or a 204-ball TFBGA package.